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Fairchild Semiconductor FDB024N06

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SEMICONDUCTOR

FDB024N06 N-Channel PowerTrench[®] MOSFET 60 V, 265 A, 2.4 mΩ

Features

- $R_{DS(on)}$ = 1.8 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 75 A
- Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

November 2013

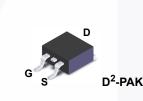
FDB024N06 — N-Channel PowerTrench[®] MOSFET

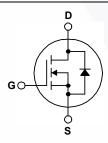
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- Motor Drives and Uninterruptible Power Supplies
- Renewable System





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		FDB024N06	Unit		
V _{DSS}	Drain to Source Voltage	60	V		
V _{GSS}	Gate to Source Voltage	±20	V		
ID		- Continuous (T _C = 25 ^o C, Silicon Limited)	265		
	Drain Current	- Continuous (T _C = 100°C, Silicon Limited)	190	A	
		- Continuous (T _C = 25°C, Package Limited)	120		
I _{DM}	Drain Current	- Pulsed (Note 1)	1060	Α	
E _{AS}	Single Pulsed Avalanche Energy	2531	mJ		
dv/dt	Peak Diode Recovery dv/dt (Note 3)		6.0	V/ns	
P _D	Dewer Dissinction	(T _C = 25°C)	395	W	
	Power Dissipation	- Derate Above 25°C	2.6	W/ºC	
T _J , T _{STG}	Operating and Storage Temperatu	-55 to +175	°C		
TL	Maximum Lead Temperature for S	300	°C		

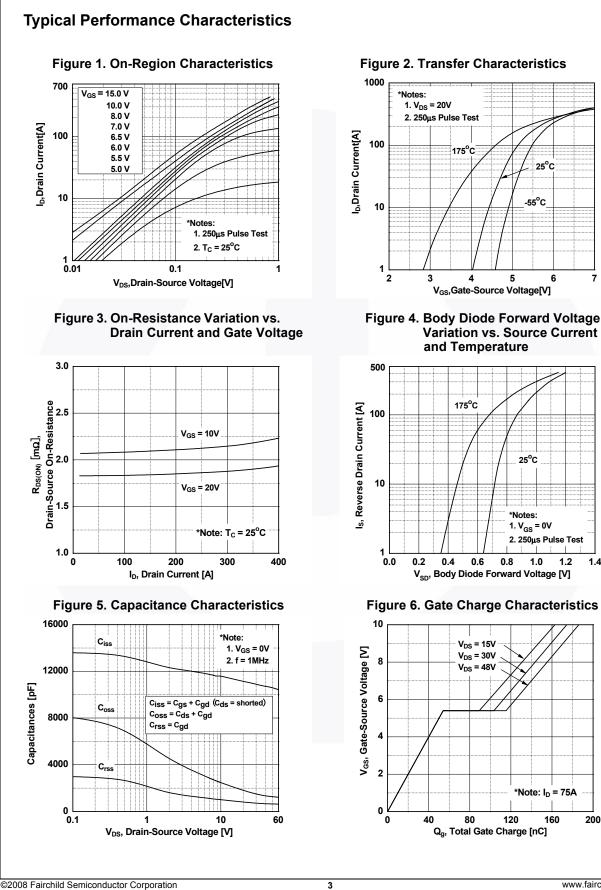
Thermal Characteristics

Symbol	Parameter	FDB024N06	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.38	
D	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	62.5	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient (1 in ² Pad of 2-oz Copper), Max.	40	



Part NumberTop MarkFDB024N06FDB024N06		Top Mark	Packa	ge	Packing Method	Reel Size	Тар	e Width	Quar	ntity
		D ² -PA	λK	Tape and Reel 330 mm		24 mm		800 units		
Electrica	l Char	acteristics ⊤ _c =	25°C unles	ss otł	nerwise noted.					
Symbol		Parameter			Test Condition	ns	Min.	Тур.	Max.	Unit
Off Chara	cteristic	S							1	
BV _{DSS}		Source Breakdown Vo	oltage	In	= 250 μA, V _{GS} = 0 V		60	_	_	V
ΔBV_{DSS} / ΔT_J		kdown Voltage Temperature		$I_D = 250 \ \mu\text{A}, \text{ Referenced to } 25^{\circ}\text{C}$			-	0.04	-	V/ºC
I _{DSS}	Zero Ga	ro Gate Voltage Drain Current		$V_{DS} = 60 V, V_{GS} = 0 V$ $V_{DS} = 60 V, V_{GS} = 0 V, T_C = 150^{\circ}C$			-	-	1 500	μA
I _{GSS}	Gate to	Body Leakage Curren	t	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			-	-	±100	nA
On Charao	cteristics	6		1						
V _{GS(th)}	Gate Th	reshold Voltage		V	_{GS} = V _{DS} , I _D = 250 μA		2.5	3.5	4.5	V
R _{DS(on)}		rain to Source On Res	istance		$_{SS} = 10 \text{ V}, \text{ I}_{D} = 75 \text{ A}$		-	1.8	2.4	mΩ
9FS		Transconductance			$_{\rm DS} = 10$ V, $I_{\rm D} = 75$ A		-	200	-	S
Dynamic (Characte	eristics						L		1
C _{iss}	1	pacitance					-	11190	14885	pF
C _{oss}	-	apacitance		$V_{\rm DS} = 25 \text{V}, \text{V}_{\rm GS} = 0 \text{V},$			-	1610	2140	pF
C _{rss}		Transfer Capacitance		f =	1 MHz	-	-	750	1125	pF
Q _{g(tot)}	Total Ga	te Charge at 10V		V	_{DS} = 48 V, I _D = 75 A,		-	174	226	nC
Q _{gs}		to Source Gate Charge			$r_{SS} = 40 \text{ V}, r_D = 73 \text{ A},$ $r_{SS} = 10 \text{ V}$	-	-	54	-	nC
Q _{gd}		Drain "Miller" Charge			33	(Note 4)	-	50	-	nC
t _{d(on)} t _r t _{d(off)}	Turn-On	On Delay Time On Rise Time Off Delay Time		V _{DD} = 30 V, I _D = 75 A, V _{GS} = 10 V, R _G = 25 Ω			-	134 324 348	278 658 706	ns ns ns
t _f		Fall Time		(Note 4)			-	250	510	ns
		le Characteristic	s			(1010 4)			0.0	
I _S		n Continuous Drain to	-	nde F	orward Current			-	265	А
I _{SM}		n Pulsed Drain to Sou					-	-	1060	A
V _{SD}		Source Diode Forward		-	$_{SS} = 0 \text{ V}, \text{ I}_{SD} = 75 \text{ A}$		-	-	1.3	V
t _{rr}		Recovery Time	. ronago		$_{SS} = 0 \text{ V}, \text{ I}_{SD} = 75 \text{ A},$		-	69	-	ns
Q _{rr}		Recovery Charge			_/dt = 100 A/μs		-	152	-	nC
2. L = 0.9 mH, I _{AS} 3. I _{SD} ≤ 75 A, di/d	t ≤ 200 A/μs, V	limited by maximum junction = 50 V, $R_G = 25 \Omega$, starting $T_J = 25 P_J = 100 P_J = $	= 25°C. °C.							





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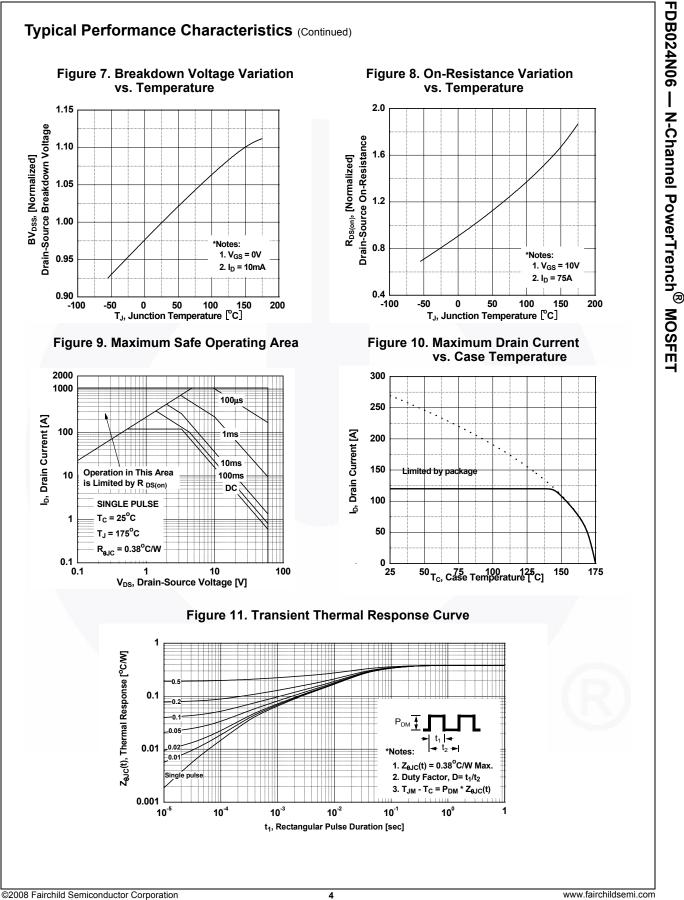
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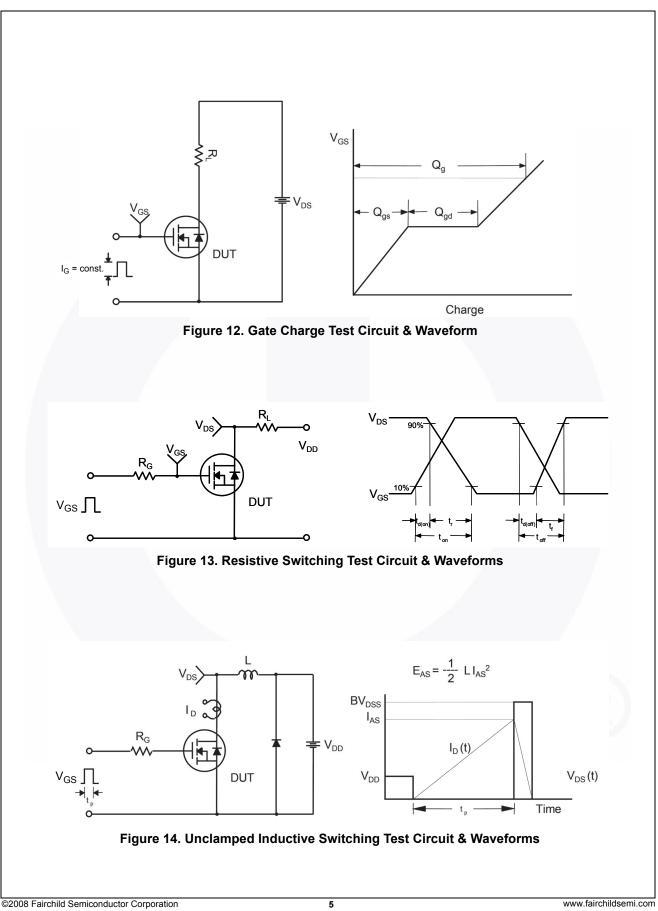




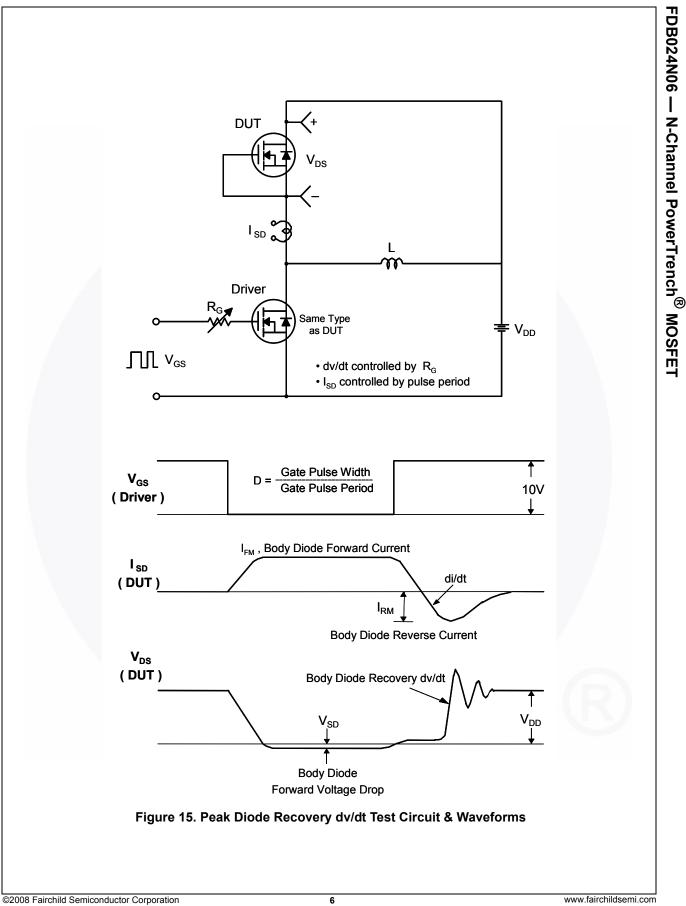
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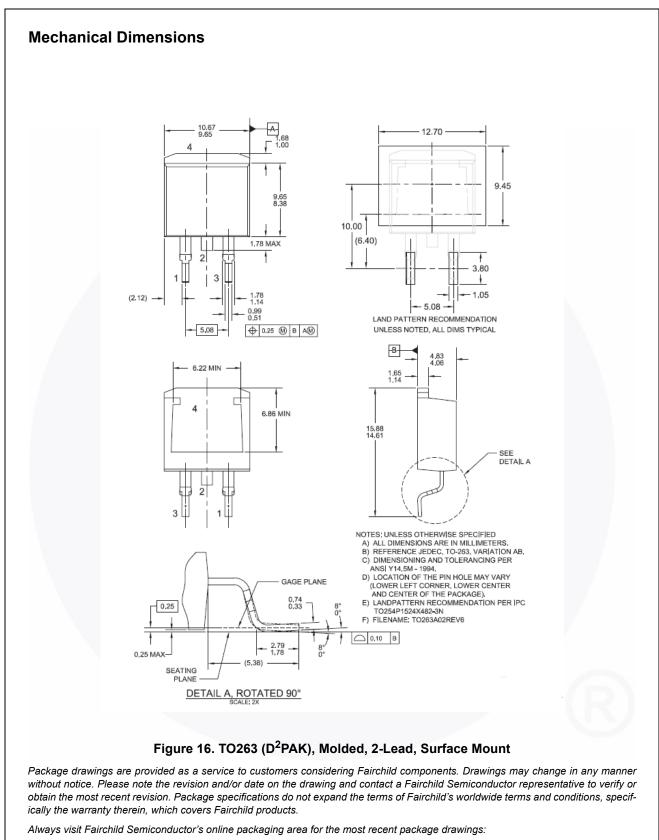
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